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Team Nexperia

# PDTA123J series

PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

Rev. 5 — 21 December 2011

**Product data sheet** 

### 1. Product profile

### 1.1 General description

PNP Resistor-Equipped Transistor (RET) family in small Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

Type number	Package	_			Package
	NXP	JEITA	JEDEC	complement	configuration
PDTA123JE	SOT416	SC-75	-	PDTC123JE	ultra small
PDTA123JM	SOT883	SC-101	-	PDTC123JM	leadless ultra small
PDTA123JT	SOT23	-	TO-236AB	PDTC123JT	small
PDTA123JU	SOT323	SC-70	-	PDTC123JU	very small

#### 1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

### 1.3 Applications

- Digital application in automotive and industrial segments
- Control of IC inputs

- Cost-saving alternative for BC847/857 series in digital applications
- Switching loads

#### 1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	-50	V
lo	output current		-	-	-100	mA
R1	bias resistor 1 (input)		1.54	2.20	2.86	kΩ
R2/R1	bias resistor ratio		17	21	26	



## 2. Pinning information

Table 3. **Pinning** Pin Simplified outline **Graphic symbol** Description SOT23; SOT323; SOT416 1 input (base) 3 2 GND (emitter) 3 output (collector) 006aaa144 sym003 **SOT883** 1 input (base) 2 GND (emitter) output (collector) Transparent top view

## 3. Ordering information

Table 4. Ordering information

Type number	Package	Package						
	Name	Description	Version					
PDTA123JE	SC-75	plastic surface-mounted package; 3 leads	SOT416					
PDTA123JM	SC-101	leadless ultra small plastic package; 3 solder lands; body 1.0 $\times$ 0.6 $\times$ 0.5 mm	SOT883					
PDTA123JT	-	plastic surface-mounted package; 3 leads	SOT23					
PDTA123JU	SC-70	plastic surface-mounted package; 3 leads	SOT323					

## 4. Marking

Table 5. Marking codes

Type number	Marking code <sup>[1]</sup>
PDTA123JE	27
PDTA123JM	DG
PDTA123JT	*23
PDTA123JU	*43

<sup>[1] \* =</sup> placeholder for manufacturing site code.

sym003

## 5. Limiting values

Table 6. Limiting values

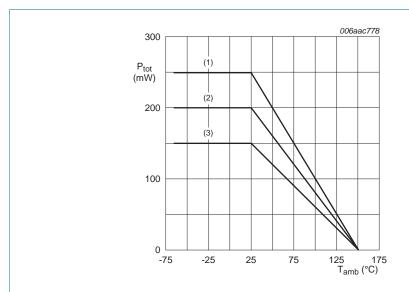
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	ı	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter		-	-50	V
$V_{CEO}$	collector-emitter voltage	open base		-	-50	V
$V_{EBO}$	emitter-base voltage	open collector		-	-10	V
VI	input voltage					
	positive			•	+5	V
	negative			-	-12	V
Io	output current			-	-100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \le 1 \text{ ms}$		-	-100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$				
	PDTA123JE (SOT416)		[1][2]	-	150	mW
	PDTA123JM (SOT883)		[2][3]	-	250	mW
	PDTA123JT (SOT23)		<u>[1]</u> .	-	250	mW
	PDTA123JU (SOT323)		<u>[1]</u> -	-	200	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature		-	-65	+150	°C
T <sub>stg</sub>	storage temperature		-	-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

<sup>[2]</sup> Reflow soldering is the only recommended soldering method.

<sup>[3]</sup> Device mounted on an FR4 PCB with 70  $\mu m$  copper strip line, standard footprint.



- SOT23; FR4 PCB, standard footprint
   SOT883; FR4 PCB with 70 μm copper strip line, standard footprint
- (2) SOT323; FR4 PCB, standard footprint
- (3) SOT416; FR4 PCB, standard footprint

Fig 1. Power derating curves

### 6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	PDTA123JE (SOT416)		[1][2]	-	830	K/W
	PDTA123JM (SOT883)		[2][3]	-	500	K/W
	PDTA123JT (SOT23)		<u>[1]</u> _	-	500	K/W
	PDTA123JU (SOT323)		<u>[1]</u> _	-	625	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Reflow soldering is the only recommended soldering method.
- [3] Device mounted on an FR4 PCB with 70  $\mu m$  copper strip line, standard footprint.

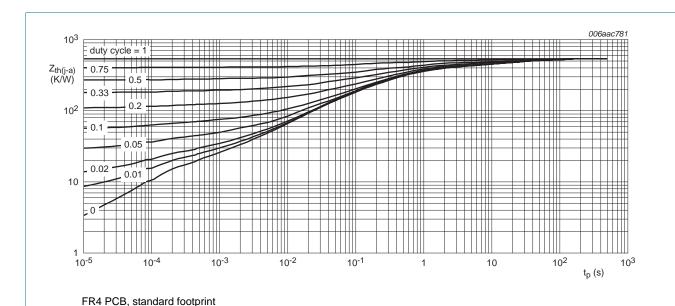


Fig 2. Transient thermal impedance from junction to ambient as a function of pulse duration for PDTA123JE (SOT416); typical values

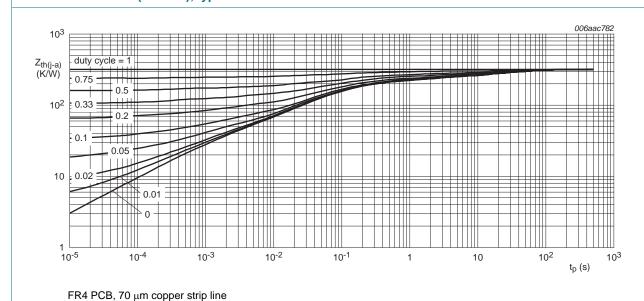


Fig 3. Transient thermal impedance from junction to ambient as a function of pulse duration for PDTA123JM (SOT883); typical values

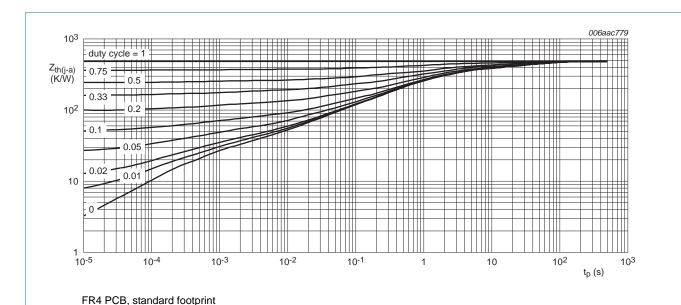


Fig 4. Transient thermal impedance from junction to ambient as a function of pulse duration for PDTA123JT (SOT23); typical values

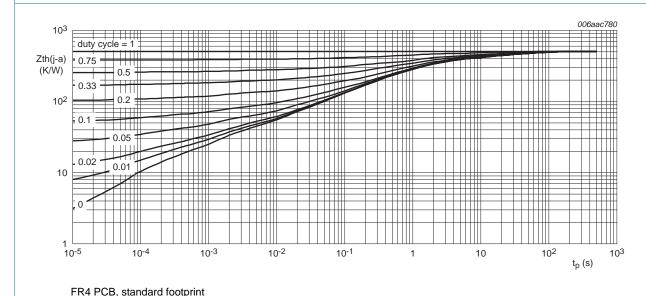


Fig 5. Transient thermal impedance from junction to ambient as a function of pulse duration for PDTA123JU (SOT323); typical values

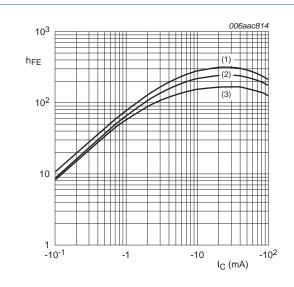
### 7. Characteristics

Table 8. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

ramb — 20	O diffees otherwise sp	comea.				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}$	-	-	-100	nA
I <sub>CEO</sub>	collector-emitter	$V_{CE} = -30 \text{ V}; I_{B} = 0 \text{ A}$	-	-	-1	μΑ
	cut-off current	$V_{CE} = -30 \text{ V; } I_{B} = 0 \text{ A;}$ $T_{j} = 150 \text{ °C}$	-	-	<b>-5</b>	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$	-	-	-180	μΑ
h <sub>FE</sub>	DC current gain	$V_{CE} = -5 \text{ V}; I_{C} = -10 \text{ mA}$	100	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = -5 \text{ mA}; I_B = -0.25 \text{ mA}$	-	-	-100	mV
$V_{I(off)}$	off-state input voltage	$V_{CE} = -5 \text{ V}; I_{C} = -100 \mu\text{A}$	-	-0.6	-0.5	V
$V_{I(on)}$	on-state input voltage	$V_{CE} = -0.3 \text{ V}; I_C = -5 \text{ mA}$	-1.1	-0.75	-	V
R1	bias resistor 1 (input)		1.54	2.20	2.86	kΩ
R2/R1	bias resistor ratio		17	21	26	
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	3	pF
f <sub>T</sub>	transition frequency	$V_{CE} = -5 \text{ V; } I_{C} = -10 \text{ mA;}$ f = 100 MHz	<u>1]</u> -	180	-	MHz

<sup>[1]</sup> Characteristics of built-in transistor.



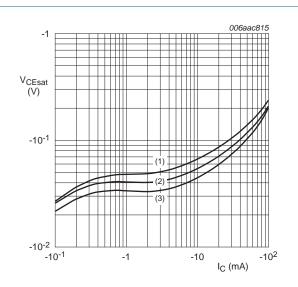
$$V_{CE} = -5 \text{ V}$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3)  $T_{amb} = -40 \, ^{\circ}C$ 

Fig 6. DC current gain as a function of collector current; typical values



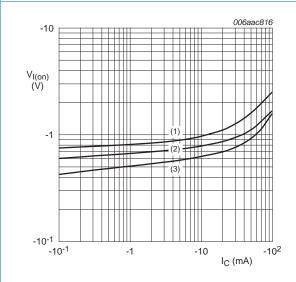
$$I_{\rm C}/I_{\rm B} = 20$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 7. Collector-emitter saturation voltage as a function of collector current; typical values



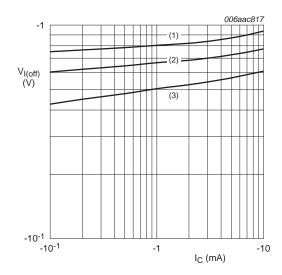


(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) T<sub>amb</sub> = 100 °C

Fig 8. On-state input voltage as a function of collector current; typical values



$$V_{CE} = -5 \text{ V}$$

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3)  $T_{amb} = 100 \, ^{\circ}C$ 

Fig 9. Off-state input voltage as a function of collector current; typical values

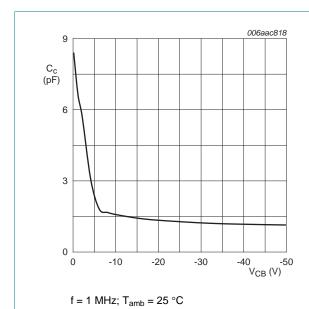


Fig 10. Collector capacitance as a function of collector-base voltage; typical values

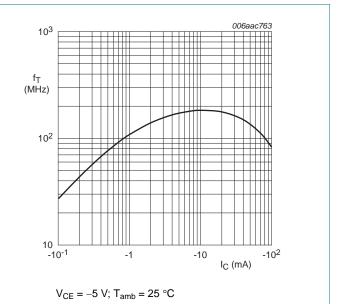


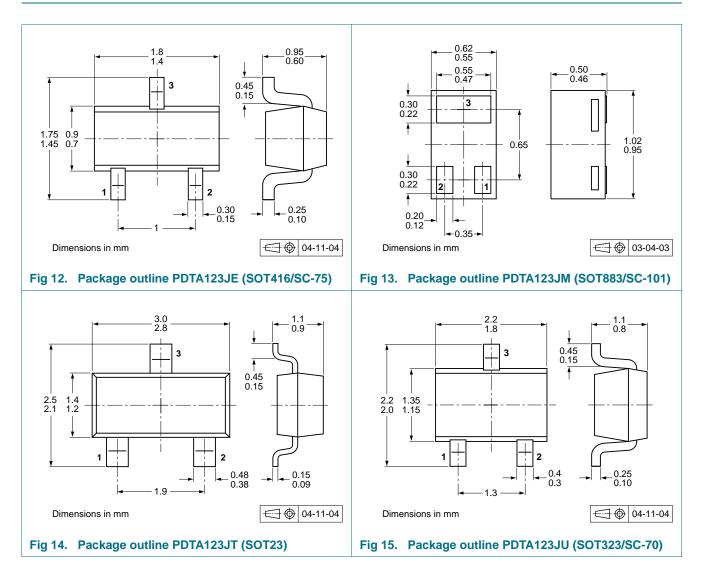
Fig 11. Transition frequency as a function of collector current; typical values of built-in transistor

### 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 9. Package outline



## 10. Packing information

Table 9. Packing methods

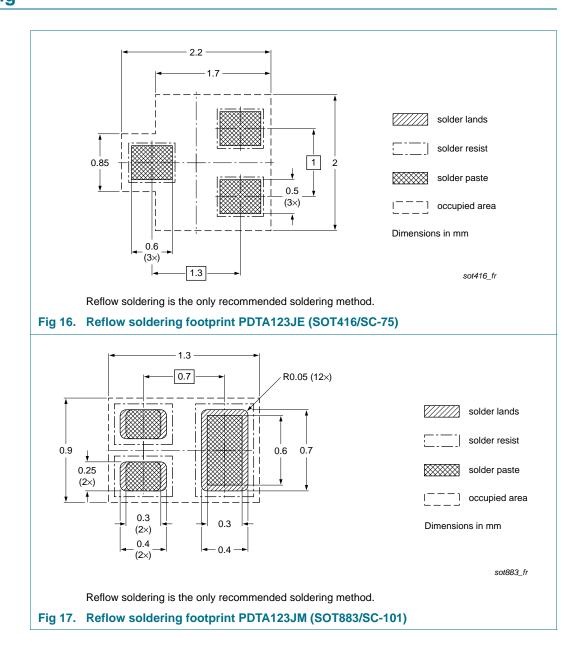
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

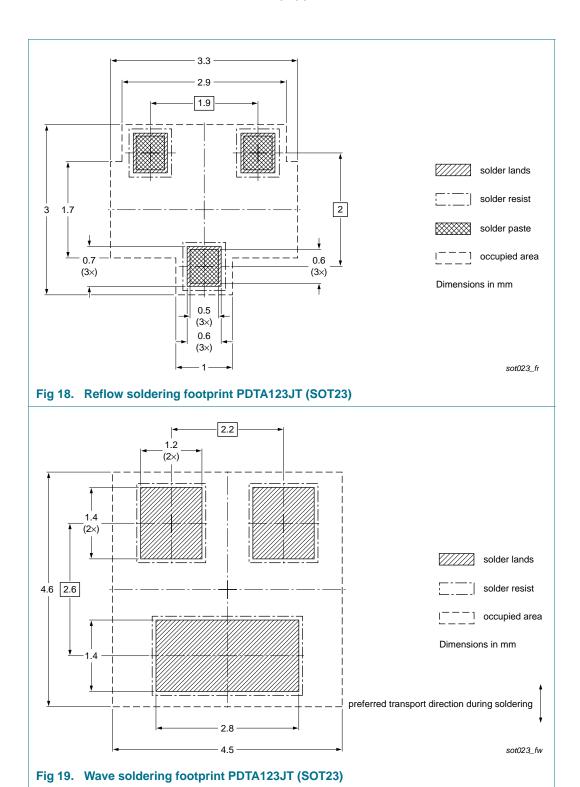
PDTA123JE         SOT416         4 mm pitch, 8 mm tape and reel         -115         -135           PDTA123JM         SOT883         2 mm pitch, 8 mm tape and reel         -         -315           PDTA123JT         SOT23         4 mm pitch, 8 mm tape and reel         -215         -235           PDTA123JU         SOT323         4 mm pitch, 8 mm tape and reel         -115         -135	Type number	Package	Description	Packing	Packing quantity		
PDTA123JM SOT883 2 mm pitch, 8 mm tape and reel315 PDTA123JT SOT23 4 mm pitch, 8 mm tape and reel -215 -235				3000	10000		
PDTA123JT SOT23 4 mm pitch, 8 mm tape and reel -215 -235	PDTA123JE	SOT416	4 mm pitch, 8 mm tape and reel	-115	-135		
	PDTA123JM	SOT883	2 mm pitch, 8 mm tape and reel	-	-315		
PDTA123JU SOT323 4 mm pitch, 8 mm tape and reel -115 -135	PDTA123JT	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235		
	PDTA123JU	SOT323	4 mm pitch, 8 mm tape and reel	-115	-135		

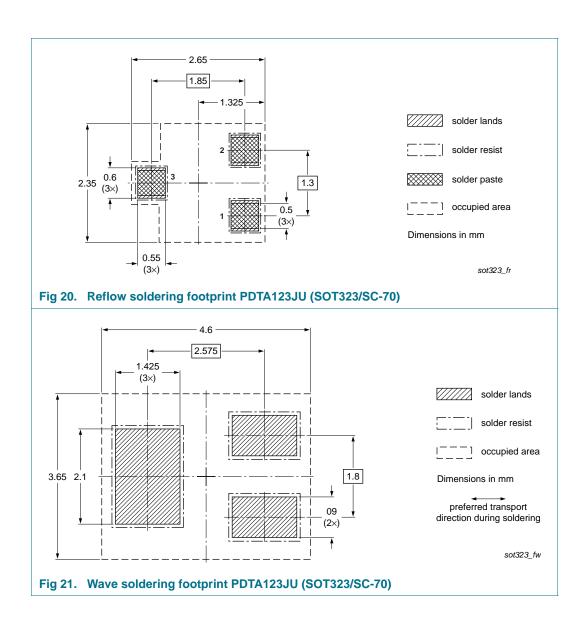
<sup>[1]</sup> For further information and the availability of packing methods, see  $\underline{\text{Section 14}}$ .

PDTA123J\_SER

## 11. Soldering







## 12. Revision history

### Table 10. Revision history

	-			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTA123J_SER v.5	20111221	Product data sheet	-	PDTA123J_SERIES v.4
Modifications:	<ul> <li>The format of guidelines of N</li> <li>Legal texts ha</li> <li>Type numbers</li> <li>Section 1 "Pro</li> <li>Figure 1 to 11:</li> <li>Table 8 "Chara V<sub>I(off)</sub> off-state</li> <li>Figure 12, 13,</li> <li>Section 8 "Tes</li> <li>Section 10 "Pa</li> </ul>	this data sheet has been NXP Semiconductors.  ve been adapted to the new PDTA123JEF, PDTA123.  aduct profile": amended added	ew company name who JK and PDTA123JS reduced to $V_{I(on)}$ on-state inpereduced and $f_T$ added by minimized package of $f_T$	with the new identity ere appropriate. emoved  ut voltage, V <sub>i(off)</sub> redefined to
		egal information": updated		
PDTA123J_SERIES v.4	20040802	Product data sheet	-	PDTA123J_SERIES v.3
PDTA123J_SERIES v.3	20030414	Product specification	-	-

### 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PDTA123J\_SER

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# PDTA123J series

PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

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